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80A 2601-CIP.

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: )  
KENICHI NAKAMURA )  
Serial No. 08/884,778 )  
Filed: June 30, 1997 )  
For: BIODEGRADABLE MOLDING MATERIAL )

Group Art Unit: 1755

Examiner: M. Marcheschi

LETTER

Hon. Commissioner of Patents and Trademarks  
Washington, D.C. 20231

Dear Sir:

In connection with the above-identified application, enclosed herewith please find one (1) corrected formal drawing sheet as requested in the Notice of Allowability dated January 4, 1999. Enclosed also is a copy of the Notice of Allowability.

Respectfully submitted,

KODA &amp; ANDROLIA

RECEIVED

MAR 30 1999

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I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents and Trademarks, Washington, D.C. 20231 on 3-23-99

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Dated 3-23-99